General purpose transistors(dual transistors)

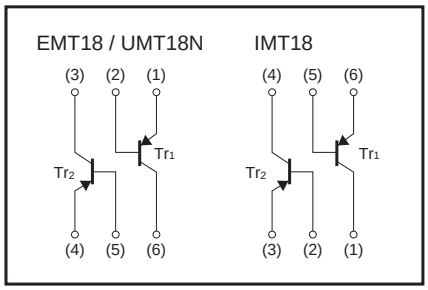
EMT18 / UMT18N / IMT18

●Features
1) Two 2SA2018 chips in a EMT package.
2) Mounting possible with EMT3 or UMT3 or SMT3 automatic mounting machines.
3) Transistor elements are independent, eliminating interference.

●Structure
Epitaxial planar type
PNP silicon transistor

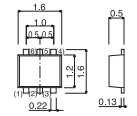
The following characteristics apply to both Tr_1 and Tr_2.

●Inner circuit



●Dimensions (Unit : mm)

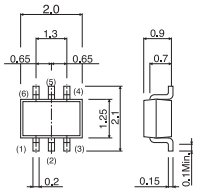
EMT18



Each lead has same dimensions

ROHM : EMT6
Abbreviated symbol : T18

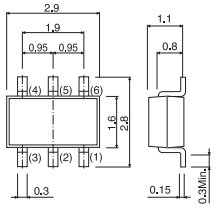
UMT18N



Each lead has same dimensions

ROHM : UMT6
EIAJ : SC-88
Abbreviated symbol : T18

IMT18



Each lead has same dimensions

ROHM : SMT6
EIAJ : SC-74
JEDEC : SOT-457
Abbreviated symbol : T18

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol		Limits	Unit
Collector-base voltage	V_{CBO}		–15	V
Collector-emitter voltage	V_{CEO}		–12	V
Emitter-base voltage	V_{EBO}		–6	V
Collector current	I_C		–500	mA
	I_{CP}		1.0 ∗1	A
Power dissipation	P_C	EMT6 UMT6	150 (TOTAL)∗2	mW
		SMT6	300 (TOTAL)∗3	
Junction temperature	Tj		150	°C
Storage temperature	Tstg		–55 to +150	°C

∗1 Single pulse Pw=1ms
∗2 120mW per element must not be exceeded.
∗3 200mW per element must not be exceeded.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	–15	–	–	V	I_C= –10μA
Collector-emitter breakdown voltage	BV_{CEO}	–12	–	–	V	I_C= –1mA
Emitter-base breakdown voltage	BV_{EBO}	–6	–	–	V	I_E= –10μA
Collector cutoff current	I_{CBO}	–	–	–0.1	μA	V_{CB}= –15V
Emitter cutoff current	I_{EBO}	–	–	–0.1	μA	V_{CB}= –6V
Collector-emitter saturation voltage	$V_{CE\ (sat)}$	–	–100	–250	mV	I_C / I_B= –200mA / –10mA
DC current transfer ratio	h_{FE}	270	–	680	–	V_{CE}= –2V, I_C= –10mA
Transition frequency	f_T	–	260	–	MHz	V_{CE}= –2V, I_E=10mA, f=100MHz
Output capacitance	Cob	–	6.5	–	pF	V_{CB}= –10V, I_E=0A, f=1MHz

●Packaging specifications and h_{FE}

Type	Package name	Taping		
	Code	T2R	TR	T110
	Basic ordering unit (pieces)	8000	3000	3000
EMT18		○	–	–
UMT18N		–	○	–
IMT18		–	–	○

●Electrical characteristic curves

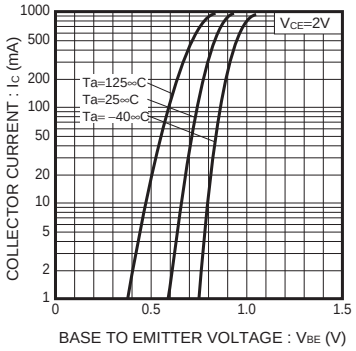


Fig.1 Grounded Emitter Propagation Characteristics

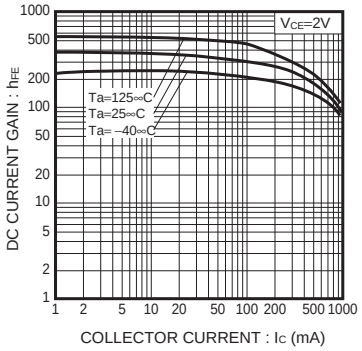


Fig.2 DC Current Gain vs. Collector Current

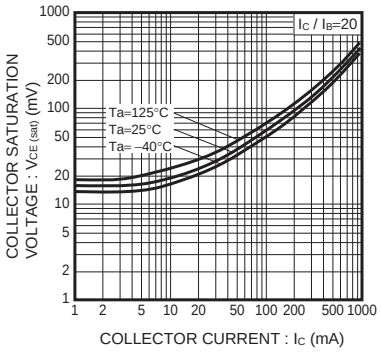


Fig.3 Collector-Emitter Saturation Voltage vs. Collector Current (I)

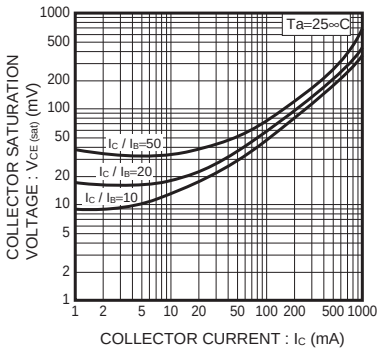


Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current (II)

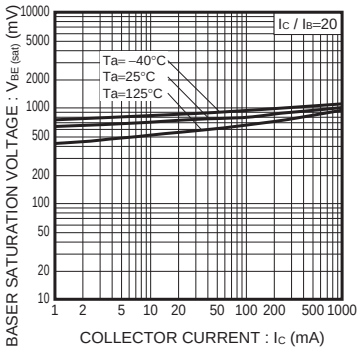


Fig.5 Base-Emitter Saturation Voltage vs.Collecter Current

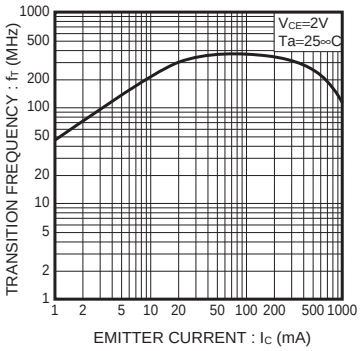


Fig.6 Gain Bandwidth Product vs. Emitter Current

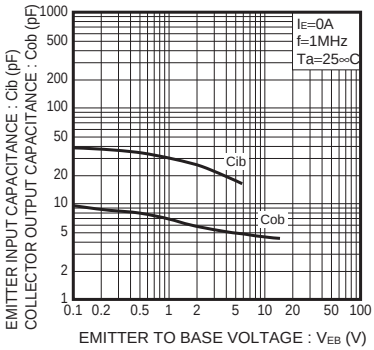


Fig.7 Collector Output Capacitance vs. Collector-Base Voltage
Emitter Input Capacitance vs. Emitter-Base Voltage

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.

ROHM SEMICONDUCTOR

Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/